PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Maciej Wojnowski	11/05/2012
Walter Hartner	10/31/2012
Ottmar Geitner	11/05/2012
Gottfried Beer	10/31/2012
Klaus Pressel	10/31/2012
Mehran Pour Mousavi	11/05/2012

RECEIVING PARTY DATA

Name:	Infineon Technologies AG
Street Address:	Am Campeon 1-12
City:	Neubiberg
State/Country:	GERMANY
Postal Code:	85579

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13736553

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: INF 2012 51784 US

PATENT

REEL: 029588 FRAME: 0873

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NAME OF SUBMITTER:	Alicia Greene	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3 source=INF2012P51784US_Declaration#page1.tif source=INF2012P51784US_Declaration#page2.tif source=INF2012P51784US_Declaration#page3.tif		

PATENT REEL: 029588 FRAME: 0874

E-Reference Number: 2012E50782 DE

Docket Number: INF 2012 P 51784 US

DECLARATION AND ASSIGNMENT FOR PATENT AND DESIGN APPLICATIONS

United States Patent Rights, on United States Plus all Foreign Patent Rights

Semiconductor Packages with Integrated Antenna and Methods of Forming Thereof

As a below named inventor (hereinafter designated as the undersigned), I hereby declare that:

	is directed to the applic				ereto, the
United States App	plication Number or PCT	International Appln	. No.		
filed on					
The above-identif	ied application was mad	le or authorized to be	e made by me.		
I believe that I am	the original inventor or	an original joint inve	ntor of a claimed i	nvention in the applicat	ion.
I have reviewed a	and understand the conte	ents of the above-ide	entified application	, including the claims.	
I acknowledge th Federal Regulation	e duty to disclose informons § 1,56.	nation which is mate	erial to patentabilit	y as defined in Title 37	, Code of
WHEREAS, the u	indersigned has invented	d certain at least one	e claim in the appl	ication identified.	
WHEREAS, Infine	eon Technologies AG				
of Am Campeon	1-12, 85579 Neubiberg,	Germany,			
acquiring the enti	ors, legal representative re right, title and interes or in the United States o	t in and to said inve			
⊠ in any foreign	countries.				
undersigned has transfer unto said territories, depen-	PRE, for good and valua (have) sold, assigned ar I Assignee the full and e dencies and possession may be granted therefo	nd transferred, and i exclusive right to the is and the entire rig	by these consider said invention in tht, title and intere	ations does (do) sell, a the United States of Ar est in and to any and a	ssign and nerica, its all Letters

possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions of all of the above for the full term or terms for which the

same may be granted.

E-Reference Number: 2012E50782 DE Docket Number: INF 2012 P 51784 US

The undersigned agrees to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof or any other proceedings before the United States Patent and Trademark Office and also to execute separate assignments in connection with such applications as the Assigned may deem necessary or expedient.

The undersigned agrees to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the international Convention for the Protection of Industrial Property or similar agreements.

The undersigned agrees to perform all affirmative acts which may be necessary to obtain a grant of (a) valid United States of America patent(s) and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorizes and requests the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has the full right to convey the entire interest herein assigned, and that he has not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grants the Assignee's legal representatives the power to insert, before or after this document has been executed by the undersigned, any information to identify the instant patent application which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office.

The undersigned hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this essignment.

The undersigned hereby acknowledges that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

In witness whereof, executed by the undersigned on the date opposite the undersigned name.

Full Name of Inventor:	Maciej Wojnowski
5/11/2012	Macy Osparl
Date	inventor's Signature
Full Name of Inventor:	Waller Hartner
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Date	inventor's Signatule
Full Name of Inventor.	Ottmar Ceitner
05 44 2042	
Date	Invenior's Signature

E-Reference Number, 2012E50782 DE

Dacket Number: INF 2012 P 51784 US

Full Name of Inventor:	Gottfried Beer
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Date	Inventor's Signature
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Full Name of Inventor:	Mehran Pour Mousavi
5.21.2012	11 Augmouri
Date	Inventor's Signature